

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5837982

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Akimasa YUASA	10/21/2019
Yusaku HARADA	10/21/2019
Takahiro NAKAMURA	10/21/2019
Shuhei MORITA	10/31/2019
Kouji NISHIMURA	10/21/2019
RECEIVING PARTY DATA	
Name:	Denka Company Limited
Street Address:	1-1, Nihonbashi-Muromachi 2-chome
Internal Address:	Chuo-ku
City:	Tokyo
State/Country:	Japan
Postal Code:	103-8338
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16616837
CORRESPONDENCE DATA	
Fax Number:	(703)836-2787
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	JAMES A. OLIFF
Address Line 1:	OLIFF PLC
Address Line 2:	P.O. BOX 320850
Address Line 4:	ALEXANDRIA, VIRGINIA 22320-4850
ATTORNEY DOCKET NUMBER:	188889
NAME OF SUBMITTER:	KARLI M. COLLINS
SIGNATURE:	/Karli M. Collins/
DATE SIGNED:	11/25/2019
This document serves as an Oath/Declaration (37 CFR 1.63).	

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Total Attachments: 4

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**ASSIGNMENT (BEING FILED FOR DUAL PURPOSE UNDER 37 CFR 1.63(e))
For Application with Filing Date on or after September 16, 2012**

ASSIGNMENT

Insert	(1) Akimasa YUASA	(2) Yusaku HARADA
(1-8) Legal Name(s)	(3) Takahiro NAKAMURA	(4) Shuhei MORITA
of Inventor(s)	(5) Kouji NISHIMURA	(6)
	(7)	(8)

In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the receipt and sufficiency of which are hereby acknowledged, each undersigned agrees to assign, and hereby does assign, transfer and set over to

(9) Insert Name of Assignee	(9) DENKA COMPANY LIMITED
(10) Insert Address of Assignee	(10) 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 103-8338, JAPAN

(hereinafter designated as the Assignee) and Assignee's heirs, successors, assigns and legal representatives, the entire right, title and interest for the United States of America as defined in 35 U.S.C. §100, in the invention, and in all applications for patent including any and all provisional, non-provisional, divisional, continuation, international, substitute and reissue application(s), and all Letters Patent, extensions, reissues and reexamination certificates that may be granted on the invention known as

(11) Insert Identification such as Title, Case Number, or Foreign Application Number	(11) CERAMIC CIRCUIT BOARD AND METHOD FOR PRODUCING SAME
	(Attorney Docket No. 188889), filed on even date herewith or as

(12) Alternative Identification for filed applications	(12) U.S. Application Number 16/616,837
	filed November 25, 2019

- 1) Each undersigned agrees to execute all papers necessary in connection with any application and/or patent for the invention and also to execute separate assignments in connection with such applications and patents as the Assignee may deem necessary.
- 2) Each undersigned agrees to execute all papers necessary in connection with any interference or post-grant proceeding which may be declared concerning any application or patent for the invention and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference or post-grant proceeding.
- 3) Each undersigned agrees to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- 4) Each undersigned agrees to perform all affirmative acts which may be necessary to obtain, maintain or confirm by reissue or reexamination a grant of a valid United States patent to the Assignee.
- 5) Each undersigned authorizes and requests the Commissioner of the U.S. Patent and Trademark Office to issue any and all patents resulting from said application(s) to the said Assignee, as Assignee of the entire interest, and covenants that he or she has full right to convey the entire interest herein assigned, and that he or she has not executed, and will not execute, any agreement(s) in conflict herewith, and agrees that this assignment is binding on Assignor and Assignor's heirs, successors, assigns and legal representatives.
- 6) Each undersigned hereby grants the firm of **OLIFF PLC** the power to insert on this assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

(13) Declaration

As an above named inventor, I hereby declare that:

I believe I am the original inventor or an original joint inventor of a claimed invention (or claimed design) in the above-identified application for which this declaration is being submitted.

The application was made or authorized to be made by me.

I have reviewed and understand the contents of the above-identified application, including the claims, and am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR §1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 21/10/2019 Inventor Signature Akimasa Yuasa (SEAL)
Akimasa YUASA

Date _____ Inventor Signature _____ (SEAL)
Yusaku HARADA

Date 21/10/2019 Inventor Signature Takahiro Nakamura (SEAL)
Takahiro NAKAMURA

Date _____ Inventor Signature _____ (SEAL)
Shuhei MORITA

Date 21/10/2019 Inventor Signature Kouji Nishimura (SEAL)
Kouji NISHIMURA

Date _____ Inventor Signature _____ (SEAL)

Date _____ Inventor Signature _____ (SEAL)

Date _____ Inventor Signature _____ (SEAL)

This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A. (b) a U.S. Consul if outside the U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:

Date _____ Witness _____

Date _____ Witness _____

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date _____ Inventor Signature _____ (SEAL)
Akimasa YUASA

Date 10/21/2019 Inventor Signature Yusaku Harada (SEAL)
Yusaku HARADA

Date _____ Inventor Signature _____ (SEAL)
Takahiro NAKAMURA

Date _____ Inventor Signature _____ (SEAL)
Shuhei MORITA

Date _____ Inventor Signature _____ (SEAL)
Kouji NISHIMURA

Date _____ Inventor Signature _____ (SEAL)

Date _____ Inventor Signature _____ (SEAL)

Date _____ Inventor Signature _____ (SEAL)

This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A. (b) a U.S. Consul if outside the U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:

Date _____ Witness _____

Date _____ Witness _____

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date _____ Inventor Signature Akimasa YUASA (SEAL)

Date _____ Inventor Signature _____ (SEAL)
Yusaku HARADA

Date _____ Inventor Signature _____ (SEAL)
Takahiro NAKAMURA

Date 31/10/2019 Inventor Signature Shuhei Morita (SEAL)
Shuhei MORITA

Date _____ Inventor Signature _____ (SEAL)
Kouji NISHIMURA

Date _____ Inventor Signature _____ (SEAL)

Date _____ Inventor Signature _____ (SEAL)

Date _____ Inventor Signature _____ (SEAL)

This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A. (b) a U.S. Consul if outside the U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:

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